LN21RPH

Round Type

ϕ5.0 mm

■ Absolute Maximum Ratings $T_a = 25°C$

Parameter	Symbol	Rating	Unit
Power dissipation	P_D	70	mW
Forward current	I_F	25	mA
Pulse forward current *	I_{FP}	150	mA
Reverse voltage	V_R	4	V
Operating ambient temperature	T_{opr}	–25 to +85	°C
Storage temperature	T_{stg}	–30 to +100	°C

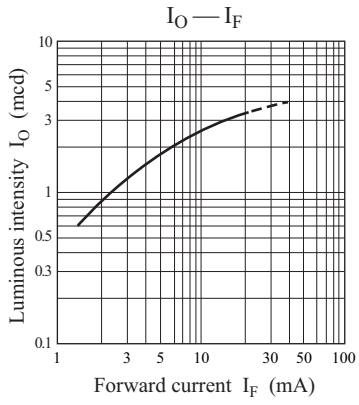
Note) *: The condition of I_{FP} is duty 10%, Pulse width 1 msec.

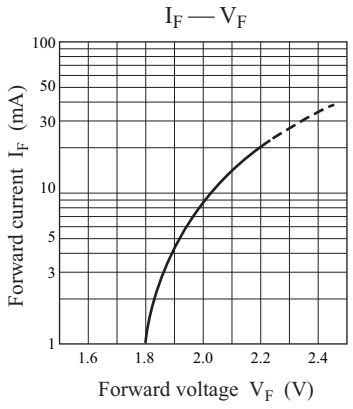
■ Lighting Color

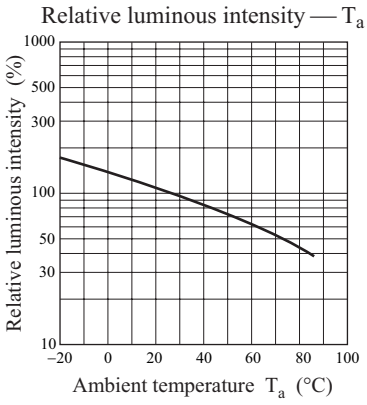
- Red

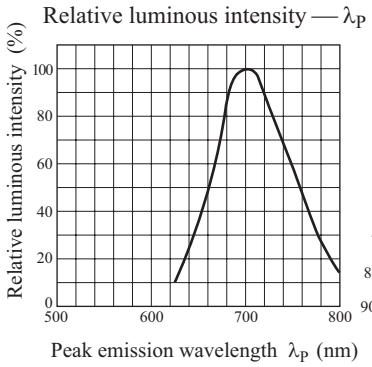
■ Electro-Optical Characteristics $T_a = 25°C$

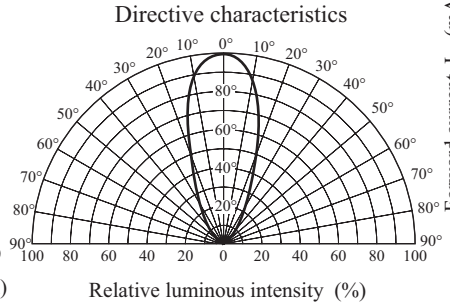
Parameter	Symbol	Conditions	Min	Typ	Max	Unit
Luminous intensity	I_O		1.0	3.0		mcd
Reverse current	I_R	$V_R = 4$ V			5	μA
Forward voltage	V_F	$I_F = 20$ mA		2.2	2.8	V
Peak emission wavelength	λ_P	$I_F = 20$ mA		700		nm
Spectral half band width	$\Delta\lambda$	$I_F = 20$ mA		100		nm

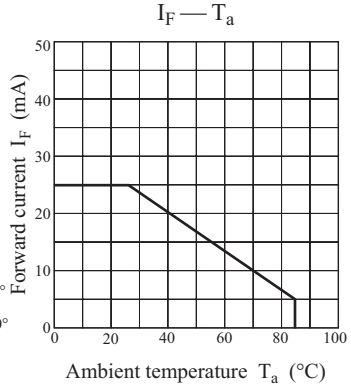






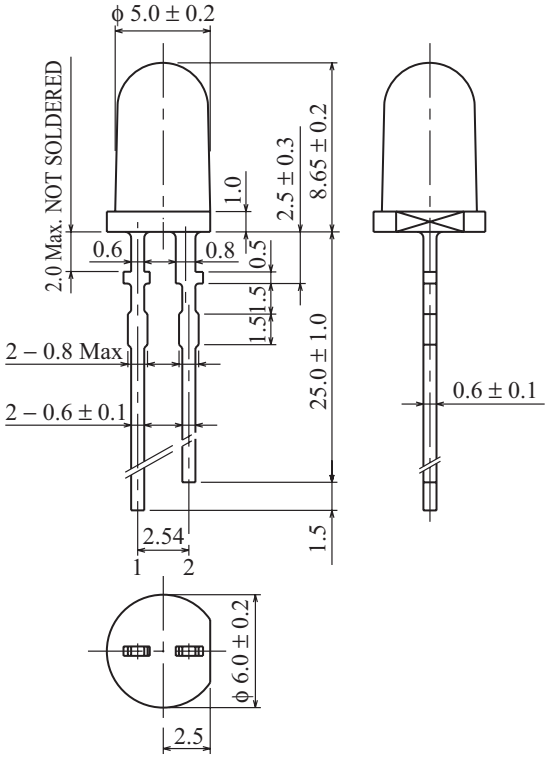






■ Package (Unit: mm)

LLXLTN2SF010



- Pin name
  1: Anode
  2: Cathode

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